

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT												
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT												
<b>CONVEYING PARTY DATA</b>													
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hideki HIRAKAWA</td> <td>12/18/2007</td> </tr> <tr> <td>Akira SOMA</td> <td>12/18/2007</td> </tr> <tr> <td>Takayuki HAYASHIZAKI</td> <td>12/18/2007</td> </tr> <tr> <td>Shinji KUNIYOSHI</td> <td>12/17/2007</td> </tr> <tr> <td>Masahisa TAZAWA</td> <td>12/18/2007</td> </tr> </tbody> </table>		Name	Execution Date	Hideki HIRAKAWA	12/18/2007	Akira SOMA	12/18/2007	Takayuki HAYASHIZAKI	12/18/2007	Shinji KUNIYOSHI	12/17/2007	Masahisa TAZAWA	12/18/2007
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<b>RECEIVING PARTY DATA</b>													
<b>Name:</b>	Kabushiki Kaisha Nihon Micronics												
<b>Street Address:</b>	6-8, Kichijojihoncho 2-chome, Musashino-shi												
<b>City:</b>	Tokyo												
<b>State/Country:</b>	JAPAN												
<b>Postal Code:</b>	180-0004												
<b>PROPERTY NUMBERS Total: 1</b>													
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11995279</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11995279								
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<b>CORRESPONDENCE DATA</b>													
<b>Fax Number:</b>	(480)385-5061												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
<b>Phone:</b>	(480) 385-5060												
<b>Email:</b>	ssolano@ifllaw.com												
<b>Correspondent Name:</b>	Ingrassia Fisher & Lorenz, P.C.												
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<b>ATTORNEY DOCKET NUMBER:</b>	065.0028US (FPN17-94US)												
<b>NAME OF SUBMITTER:</b>	Mark Takahashi												

CH \$40.00 11995279

Total Attachments: 2

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United States Utility Patent Application  
Attorney Docket No.: 065 0028US (FPN17-94US)  
First Named Inventor: Hideki HIRAKAWA

### ASSIGNMENT

**WHEREAS**, the undersigned inventor(s) (hereinafter individually and collectively referred to as "ASSIGNOR") have invented:

#### ELECTRICAL TEST PROBE

for which application for Letters Patent of the United States:

- has been executed on even date herewith;
- executed on \_\_\_\_\_;
- was filed on January 10, 2008 and assigned U.S. application no. 11/995,279;  
(I hereby allow and request the filing date and application number be entered here by the agent of record upon filing of the application.)

**AND WHEREAS**, Kabushiki Kaisha Nihon Micronics, having a place of business at 6-8, Kichijojihoncho 2-chome, Musashino-shi, Tokyo 180-0004, Japan (hereinafter "ASSIGNEE"), and its successors, assigns, and legal representatives, is desirous of acquiring an interest therein;

**AND WHEREAS**, a "formal application," as referred to herein, shall mean any provisional, nonprovisional, continuation, continuation in part, continued prosecution, substitute, renewal, extension, divisional, reissue, reexamination, foreign, Patent Cooperation Treaty (PCT) or other patent application, inventor's certificate, or like document;

**NOW, THEREFORE**, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNOR does hereby sell, assign and transfer unto ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right to the aforesaid application, to the invention as described in the aforesaid application, and to any formal application which may be filed based in whole or in part on the aforesaid application, in the United States and all foreign countries, together with the right of priority under any international agreements to which the United States currently adheres and adheres to in the future, and hereby authorizes and requests the Commissioner of Patents to issue said Letters Patent to ASSIGNEE, for the sole use and benefit of ASSIGNEE, its successors, assigns and legal representatives,

**AND ASSIGNOR HEREBY AGREES** to transfer, upon request of ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, a like interest in and to any improvements and formal applications based thereon, growing out of or relating to the invention; and, without further remuneration, to provide all reasonable assistance and execute any papers requested by ASSIGNEE, its successors, assigns and legal representatives, to preserve and/or acquire ASSIGNEE's full protection and title in and to the invention hereby transferred and any improvements therein,

**ASSIGNOR AGREEING, FURTHERMORE**, upon request of ASSIGNEE, and without further remuneration, to execute any and all papers desired by ASSIGNEE for the filing and granting of formal applications based on the invention or improvements therein, and the perfecting of title thereto in ASSIGNEE.

**EXECUTED** as of the date(s) written below by ASSIGNOR:

Hideki HIRAKAWA  
Inventor's Signature

Date: Dec. 18, 2007

Hideki HIRAKAWA  
Inventor's Printed Name

Akira Soma  
Inventor's Signature

Date: Dec. 18, 2007

Akira SOMA  
Inventor's Printed Name

Takayuki Hayashizaki  
Inventor's Signature

Date: Dec. 18, 2007

Takayuki HAYASHIZAKI  
Inventor's Printed Name

Shinji Kuniyoshi  
Inventor's Signature

Date: Dec. 17, 2007

Shinji KUNIYOSHI  
Inventor's Printed Name

Masahisa Tazawa  
Inventor's Signature

Date: Dec. 18, 2007

Masahisa IAZAWA  
Inventor's Printed Name